


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	MDG/19/11335	
1.3 Title of PCI	AMKOR ATT (Taiwan) final test line moving from site T3 to site T6	
1.4 Product Category	STM32F446MEY6TR , STM32L476JGY6TR , STM32L476MGY6TR	
1.5 Issue date	2019-06-18	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	FRANCKE CHRISTIANE
2.1.2 Phone	+49 89460062128
2.1.3 Email	christiane.francke@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Ricardo Antonio DE SA EARP
2.1.2 Marketing Manager	Veronique BARLATIER
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Testing (SOP 2617)	Site T3 & T6 both located in Taiwan.

4. Description of change

	Old	New
4.1 Description	AMKOR ATT (Taiwan) final test is located in site T3	AMKOR ATT (Taiwan) final test will be located in site T6
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Change	

5. Reason / motivation for change

5.1 Motivation	Consolidation of AMKOR ATT (Taiwan) final test area in T6 for WLCSP packages.
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	Traceability of the change is ensured by ST internal tools.
------------------------	---

7. Timing / schedule

7.1 Date of qualification results	2019-06-13
7.2 Intended start of delivery	2019-07-10
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation

8.1 Description	11335 MDG-MCD-RER1910 PCN11330-ST MUAR HD line capacity extension STM8 & STM32 LQFP 10x10 64L.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2019-06-18

9. Attachments (additional documentations)

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
2488308	STM32F446MEY6TR	

IMPORTANT NOTICE – PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2018 STMicroelectronics – All rights reserved